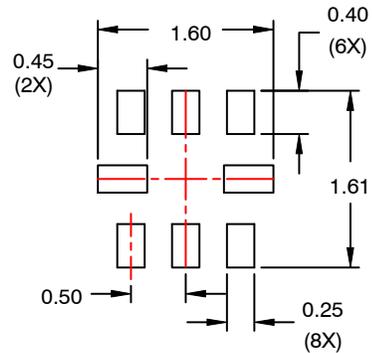
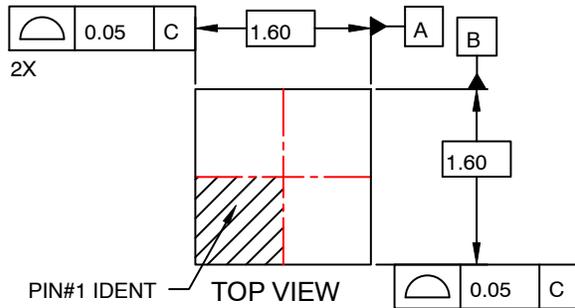
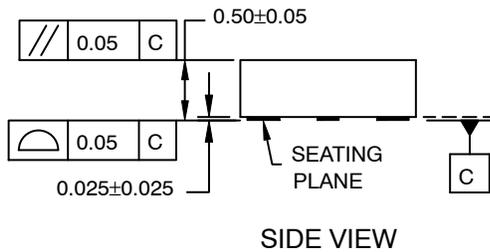


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ISSUE O

DATE 31 AUG 2016



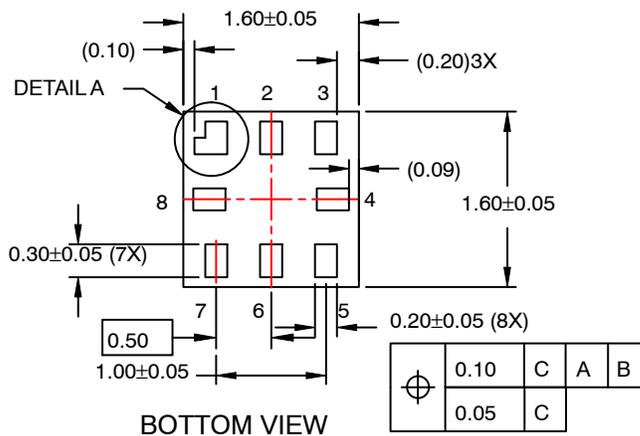
**RECOMMENDED
LAND PATTERN**



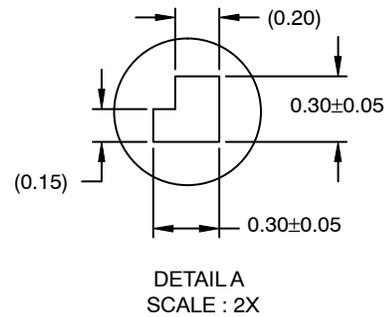
SIDE VIEW

NOTES:

- A. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.



BOTTOM VIEW



**DETAIL A
SCALE : 2X**

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